



DOCKET NO. PHA23-843A

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Majid et al.

Examiner: Parekh, N.

Application No.: 09/440,595

Art Unit: 2811

Filed: 11/15/1999

For: MULTIPLE SEMICONDUCTOR CHIP  
(MULTI-CHIP) MODULE FOR USE IN  
POWER APPLICATIONS

Mail Stop Non-Fee Amendments  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

TECHNOLOGY CENTER 2800  
JUN 17 2003  
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J. Mcmillan  
6/28/03

REQUEST FOR RECONSIDERATION

Sir:

In response to the Office Action of March 13, 2003, Applicants respectively request that the above-identified application be reconsidered in view of the remarks that follow, that each of the presently pending claims be allowed, and that the application be passed to issue.

REMARKS

Claims 1-7 are pending.

Claims 1-7 are rejected under 35 U.S.C. §103(a) as being unpatentable over Takagi et al. (US 6,130,458), hereafter "Takagi," in view of Lauffer et al. (EP 0 471 938 A1), hereafter